

New insights into the electron trapping mechanism in LaAlO₃/SrTiO₃ heterostructures

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In LaAlO₃/SrTiO₃ heterostructures, a commonly observed but poorly understood phenomenon is that of electron trapping in back-gating experiments. In this work, by combining magnetotransport measurements and self-consistent Schrödinger-Poisson calculations, we obtain an empirical relation between the amount of trapped electrons and the gate voltage. We find that the trapped electrons follow an exponentially decaying spatial distribution away from the interface. However, contrary to earlier observations, we find that the Fermi level remains well within the quantum well. The enhanced trapping of electrons induced by the gate voltage can therefore not be explained by a thermal escape mechanism. Further gate sweeping experiments strengthen our conclusion that the thermal escape mechanism is not valid. We propose a new mechanism which involves the electromigration and clustering of oxygen vacancies in SrTiO₃. Our work indicates that electron trapping is a universal phenomenon in SrTiO₃-based two-dimensional electron systems.

The capability of controlling the electronic properties of a material by applying an external voltage is at the heart of modern electronics. In particular in oxide heterostructures, there is a constant search to manipulate their novel functionalities with an externally applied electric field [1]. The most well-known example is the quasi-two-dimensional electron gas (Q2DEG) discovered at the interface between LaAlO₃ (LAO) and SrTiO₃ (STO) [2]. The Q2DEG exhibits intriguing physical properties, such as superconductivity [3], signatures of magnetism [4–6] and even their coexistence [7, 8]. Additionally, due to the large permittivity of the STO substrate [9], the carrier density and mobility of the Q2DEG can be modulated by a back-gate voltage (V_G). Gate-tunable insulator to metal transitions [10], insulator to superconductor transitions [11] and Rashba spin-orbit interactions [12, 13] have been reported. At the LAO/STO interface, the Q2DEG is confined in a quantum well (QW) on the STO side and the band structure is formed by the Ti t_{2g} orbitals. For LAO films grown on STO (001) substrates, the d_{xy} band lies below the $d_{xz,yz}$ bands in energy [14–16]. Applying V_G across the STO substrate changes the carrier density in the QW. A Lifshitz transition occurs when the Fermi level is tuned across the bottom of the $d_{xz,yz}$ bands [17].

In back-gating experiments, a commonly observed phenomenon is that the sheet resistance (R_s) follows an irreversible route when V_G is swept first forward (increasing V_G) and then backward (decreasing V_G) [11, 18–22]. The explanation as given by Biscaras *et al.* [19] is that the Fermi level lies intrinsically close to the top of the QW. High-mobility electrons escape from the QW and

get trapped in STO when the carrier density is beyond a threshold. But the relations between the amount of trapped electrons, their spatial distribution, and the gate voltage are still unknown. In this Letter, we study these relations by combining magnetotransport measurements and self-consistent Schrödinger-Poisson calculations. We find that the earlier proposed thermal escape mechanism cannot be reconciled with our results. We perform further gate sweeping experiments which strengthen this conclusion. We propose a new mechanism which involves the electromigration and clustering of oxygen vacancies in SrTiO₃.

The back-gating experiments were performed on Hall bar devices as depicted in the inset of Fig. 1(a). The length and width are 1000 μm and 150 μm , respectively. First, a sputtered amorphous AlO_x hard mask in form of a negative Hall bar geometry (thickness ~ 15 nm) was fabricated on a TiO₂-terminated STO (001) substrate by photolithography. Then, 15 unit cells of LAO film were deposited at 800 $^\circ\text{C}$ in an Ar pressure of 0.04 mbar by 90 $^\circ$ off-axis sputtering [23]. Finally, the sample was *in situ* annealed at 600 $^\circ\text{C}$ in 1 mbar of oxygen for 1 h. The back-gate electrode was formed by uniformly applying a thin layer of silver paint (Ted Pella, Inc.) on the back of the substrate. The detailed device fabrication process is described in the Supplemental Material [24]. The longitudinal resistance (R_{xx}) and transverse resistance (R_{xy}) were measured simultaneously by standard lock-in technique ($f = 13.53$ Hz and $i_{\text{RMS}} = 1.0$ μA). Magnetotransport measurements were performed under different V_G at 4.2 K in a superconducting magnet with the magnetic

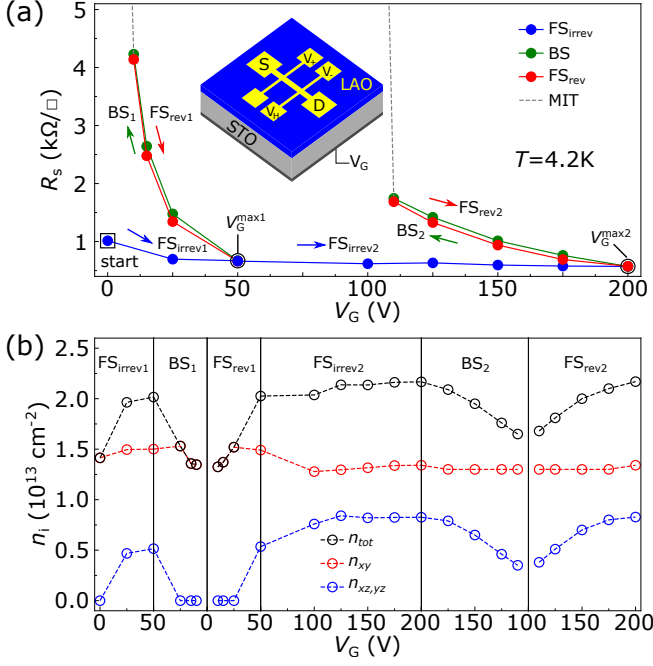


FIG. 1. (a) V_G dependence of sheet resistance (R_s) at 4.2 K. The solid circles are $R_s(B = 0)$ in magnetoresistance curves. The blue, green and red arrows indicate the irreversible forward sweep (FS_{irrev}), backward sweep (BS), and reversible forward sweep (FS_{rev}), respectively. Two BSs were performed at 50 V ($V_G^{\max 1}$) and 200 V ($V_G^{\max 2}$). The gray dashed line indicates the metal-insulator transition (MIT). The inset shows a schematic of the Hall bar device. Source and drain are labeled as S and D. The longitudinal resistance (R_{xx}) is measured between V_+ and V_- and the transverse resistance (R_{xy}) between V_H and V_- . V_G is applied between the back of the substrate and the drain. (b) V_G dependence of the carrier density in different sweeping regimes. The blue and red circles represent the carrier density of the d_{xy} band (n_{xy}) and $d_{xz,yz}$ band ($n_{xz,yz}$). The black circle is the total carrier density (n_{tot}) which is the sum of n_{xy} and $n_{xz,yz}$.

field swept between ± 15 T. The maximum applied V_G was +200 V and the leakage current was less than 1 nA during the measurement.

The device was cooled down to 4.2 K with V_G grounded. Fig. 1(a) shows the V_G dependence of the sheet resistance, R_s . V_G was first increased from 0 V to 50 V ($V_G^{\max 1}$), resulting in a decrease of R_s . This sweep is called an irreversible forward sweep (FS_{irrev}), because R_s increased above the virgin curve when V_G was swept backward. The backward sweep (BS) led to a metal-insulator transition (MIT), which is consistent with earlier reports [20, 25]. After the onset of the MIT, defined from the phase shift of the lock-in amplifier increasing above 15° , V_G was further decreased to completely deplete the QW. When V_G was swept forward again, R_s followed the same route as the BS. Therefore the latter forward sweep is named a reversible forward sweep (FS_{rev}). Another BS was performed at 200 V ($V_G^{\max 2}$). It can be seen that R_s increased faster in BS₁ than in

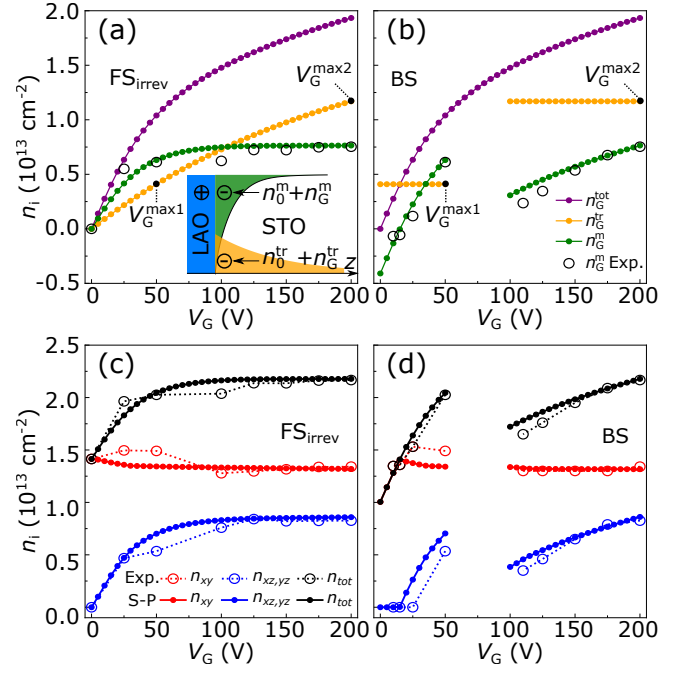


FIG. 2. (a)-(b) V_G dependence of the calculated gate-induced total charge density (n_G^{tot} , purple), trapped charge density (n_G^{tr} , yellow), mobile charge density (n_G^{m} , green) and measured gate-induced mobile charge density (n_G^{m} Exp., open black circle) in (a) FS_{irrev} and (b) BS regimes. The inset of (a) shows an illustration of the interface for Schrödinger-Poisson calculations. (c)-(d) V_G dependence of S-P calculated (solid circles) and measured (open circles) n_{xy} (red), $n_{xz,yz}$ (blue) and n_{tot} (black) in (a) FS_{irrev} and (b) BS regimes.

BS₂, and the reason of which will be discussed later.

Fig. 1(b) shows the V_G dependence of the carrier density of both d_{xy} (n_{xy}) and $d_{xz,yz}$ ($n_{xz,yz}$) bands and the total carrier density (n_{tot}). The values were extracted by fitting the magnetotransport data with a two-band model [24, 26]. It can be seen that only the d_{xy} band was occupied at 0 V. In FS_{irrev1}, electrons were added into the QW and the Lifshitz transition occurred at a carrier density (n_L) of $1.51 \times 10^{13} \text{ cm}^{-2}$, which is close to earlier reported values [17]. In BS₁, n_{tot} decreased to $1.33 \times 10^{13} \text{ cm}^{-2}$ at 10 V, which is the onset of the MIT, comparable to the earlier reported carrier density ($0.5 - 1.5 \times 10^{13} \text{ cm}^{-2}$) for the MIT [27]. In FS_{rev1}, the carrier densities of the bands were tuned reversibly as in BS₁ and the system was fully recovered when 50 V was reapplied. In FS_{irrev2}, n_{tot} saturated at $2.17 \times 10^{13} \text{ cm}^{-2}$ beyond 125 V. In BS₂, the MIT occurred at 110 V with a carrier density of $1.65 \times 10^{13} \text{ cm}^{-2}$, which could be due to the Hall bar contacts becoming insulating faster than the channel [28]. A noteworthy feature is that the amount of gate-induced trapped electrons is independent of the number of backward sweeps and is only related to V_G^{\max} .

First, we study the relation between the amount of trapped electrons and the gate voltage. In a back-gating experiment, the total amount of electrons (n_G^{tot}) induced

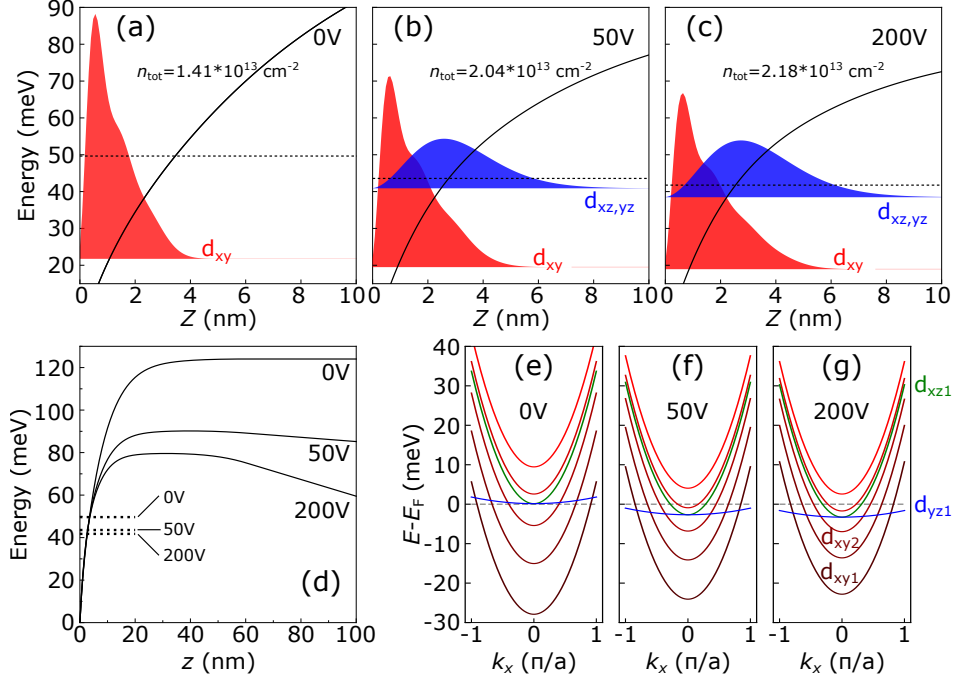


FIG. 3. (a)-(c) S-P calculated confining potential profile (solid line), Fermi energy (dotted line), and spatial distribution of mobile electrons occupying d_{xy} (red) and $d_{xz,yz}$ (blue) bands at (a) 0 V, (b) 50 V and (c) 200 V. (d) S-P calculated confining potential profile and Fermi energy in a larger range. (e)-(f) S-P calculated subband dispersions in parabolic approximation at (e) 0 V, (f) 50 V and (g) 200 V.

by V_G , as shown by the purple curves in Fig. 2(a) and 2(b), can be calculated using a parallel plate capacitor model [29, 30]:

$$n_G^{\text{tot}}(V_G) = \frac{\epsilon_0}{ed_{\text{STO}}} \epsilon_r(V_G) V_G, \quad (1)$$

where ϵ_0 is the vacuum permittivity, e is the electron charge and d_{STO} is the thickness of the STO substrate (0.5 mm). The field-dependent permittivity of the STO substrate $\epsilon_r(V_G)$ is calculated following Ref. [31]:

$$\epsilon_r(E) = 1 + \frac{B}{[1 + (E/E_0)^2]^{1/3}}, \quad (2)$$

where the electric field $E = V_G/d_{\text{STO}}$, $B = 2.55 \times 10^4$ and $E_0 = 8.22 \times 10^4$ V/m. In FS_{irrev} regimes, as shown in Fig. 2(a), a part of n_G^{tot} becomes gate-induced trapped electrons (n_G^{tr}) in STO. Subtracting n_G^{tr} from n_G^{tot} will give the amount of gate-induced mobile electrons (n_G^{m}) which are doped into the QW. We find that the relation between n_G^{tr} and V_G can be described using the following expression:

$$n_G^{\text{tr}}(V_G) = N(1 - e^{-\frac{V_G}{200}}), \quad (3)$$

which yields the yellow curve, where $N = 1.85 \times 10^{13} \text{ cm}^{-2}$. The subtraction ($n_G^{\text{tot}} - n_G^{\text{tr}} = n_G^{\text{m}}$) is given by the green curve, and gives a good description of the measured n_G^{m} (open black circle). In BS regimes,

as shown in Fig. 2(b), n_G^{tot} is given by V_G according to Eq. (1). However, the value of n_G^{tr} is fixed at the $n_G^{\text{tr}}(V_G^{\text{max}})$. Thus, n_G^{m} is smaller than its counterpart in FS_{irrev} regimes. In both BS regimes the calculated n_G^{m} is in good agreement with the experimental data. Moreover, due to the field-dependent permittivity, dn_G^{tot}/dV_G is decreasing as V_G increases. As a consequence, the same negative ΔV_G removes more mobile electrons at 50 V than at 200 V, which could explain the fact that R_s increases faster in BS_1 than in BS_2 . It should be noted that the empirical formula of $n_G^{\text{tr}}(V_G)$ is not universal, but instead varies among samples. We performed similar V_G sweeps on two reference samples and observed slightly different V_G dependence of R_s (see Fig. S5 in Ref. [24]). Thus, $n_G^{\text{tr}}(V_G)$ should always be obtained from experimental results.

Next, we study the spatial distribution of the trapped electrons. The self-consistent Schrödinger-Poisson (S-P) model is a tool to study the charge distribution and band occupation [16, 26, 32–34]. S-P calculations are based on the effective mass and envelope wave function approximations. Due to the orbital orientation, d_{xy} and $d_{xz,yz}$ orbitals are heavy and light in the z direction, respectively. Here, we take the effective mass as $m_{xy}^{*z} = 14 m_e$ and $m_{xz,yz}^{*z} = 0.7 m_e$ [15, 16, 33], where m_e is the electron rest mass. We take $z > 0$ to be STO and $z < 0$ to be LAO, as shown in the inset of Fig. 2(a). In the original state, there are initial mobile electrons (n_0^{m} , $1.41 \times 10^{13} \text{ cm}^{-2}$ in our sample) and initial trapped electrons (n_0^{tr}) on the

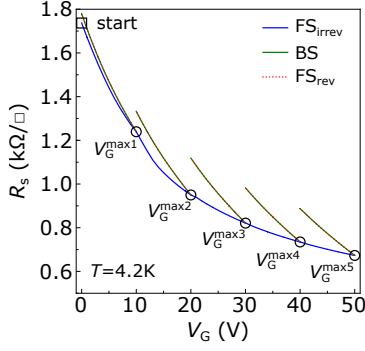


FIG. 4. V_G dependence of R_s at 4.2 K. Backward sweeps were performed from 10 V to 50 V. Note that BS and FS_{rev} overlap perfectly.

STO side, and an equivalent amount of positive charges on the LAO side to keep overall charge neutrality.

The spatial distributions of the trapped electrons, both n_0^{tr} and $n_G^{\text{tr}}(V_G)$, are input parameters of the S-P model, which effectively influence the V_G dependent occupation of the d_{xy} and $d_{xz,yz}$ bands. In our calculations, we obtain the best results by using the following distribution of the trapped electrons:

$$n_{3D}^{\text{tr}}(z, V_G) = \begin{cases} 0 & \text{for } z < 0 \\ \frac{n_0^{\text{tr}} + n_G^{\text{tr}}(V_G)}{\lambda} e^{-\frac{z}{\lambda}} & \text{for } z \geq 0 \end{cases} \quad (4)$$

where $n_0^{\text{tr}} = 6.4 \times 10^{13} \text{ cm}^{-2}$ and $\lambda = 30 \text{ nm}$. The integration range is from 0 nm to 100 nm, which is divided into 2000 equal sections. The calculated evolutions of n_{xy} and $n_{xz,yz}$ in FS_{irrev} and BS regimes are shown in Fig. 2(c) and 2(d), closely agreeing with the experimental data.

Based on the above analysis, we could obtain the confining potential profile, the Fermi energy and the spatial distribution of mobile electrons occupying the d_{xy} and $d_{xz,yz}$ bands. Fig. 3(a)-(c) show the results at 0 V, 50 V and 200 V, respectively. The mobile electrons are confined within $\sim 10 \text{ nm}$ at the interface, which agrees with the reported spatial distribution of the Q2DEG [35–37]. Fig. 3(d) shows the confining potential in a larger range. It can be seen that in all cases the Fermi level is well below the top of the QW, therefore the probability of mobile electrons thermally escaping ($k_B T(4.2 \text{ K}) \approx 0.36 \text{ meV}$) from the QW should be very low. The subband dispersions of the three cases are shown in Fig. 3(e)-(g). We note that increasing V_G decreases the spacing between the subband levels.

In order to check the thermal escape mechanism [19] in more detail, we warmed up the device to room temperature to remove the electron trapping effect [18]. The device was cooled down to 4.2 K again and multiple backward sweeps were performed from 10 V to 50 V. As shown in Fig. 4, a growing R_s separation between FS_{irrev} and BS can be clearly seen as V_G^{max} increases. In the thermal escape mechanism, it is stated that electron trapping

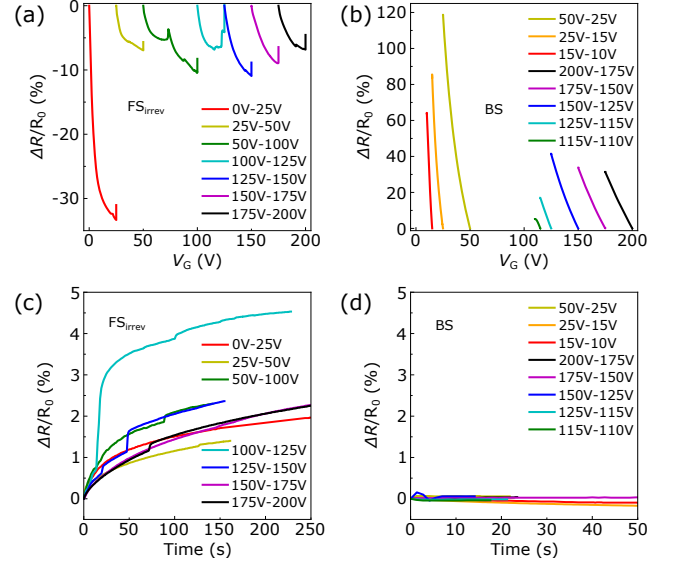


FIG. 5. (a)-(b) Dynamic change of R_s during V_G sweeps in (a) FS_{irrev} and (b) BS regimes. V_G was swept at a rate of 0.1 V/s. R_s measurements kept on going for several minutes after the stabilization of V_G . (c)-(d) Dynamic change of R_s after V_G sweeps in (c) FS_{irrev} and (d) BS regimes.

only occurs after R_s (or n_{tot}) reaches its saturation. However, our experiment clearly shows that electron trapping occurs immediately when positive V_G is applied and the amount of trapped electrons increases as V_G^{max} increases. So we can rule out the thermal escaping of mobile electrons to be the mechanism for electron trapping. Moreover, similar irreversible behavior has been also reported in other Q2DEG systems, such as $\text{LaTiO}_3/\text{STO}$ [19], LaVO_3/STO [21], $(\text{LaAlO}_3)_{0.3}(\text{Sr}_2\text{AlTaO}_6)_{0.7}/\text{STO}$ [38] and amorphous LAO/STO [39]. Therefore the electron trapping phenomenon must be intrinsic to the STO substrate.

We propose a two-step trapping mechanism which involves the redistribution of oxygen vacancies (V_{O}) in STO under influence of an electric field. The first step is the electromigration of V_{O} . Among all types of defects in STO, V_{O} has the lowest activation enthalpy for migration [40]. Electromigration of V_{O} in STO has been reported in previous works [41–43]. The second step is the clustering of V_{O} . It has been calculated that V_{O} clustering could form in-gap trapping states [44, 45], of which the energy was recently determined to be $\sim 0.31 \text{ eV}$ and $\sim 1.11 \text{ eV}$ below the conduction band [46]. Fig. 5 shows the dynamic resistance change during and after V_G sweeps in the FS_{irrev} and BS regimes. The electron trapping mechanism can then be explained as follows. In FS_{irrev} regimes as shown in Fig. 5(a), the effect of increasing V_G is twofold. One is to add electrons into the QW. The other is to push positively charged V_{O} s migrating toward the interface. The clustering of the accumulated V_{O} s then forms in-gap trapping states. Several sudden resistance jumps can be clearly seen during V_G

sweeps, which might be due to the formation of big V_O clusters. Moreover, after stabilizing the gate voltage as shown in Fig. 5(c), the electromigration and clustering of V_O s do not stop immediately. Newly formed in-gap states still trap conduction electrons, resulting in an immediate increase of R_s when V_G stabilizes. In BS and FS_{rev} regimes as shown in Fig. 5(b) and 5(d), sweeping V_G only changes the carrier density in the QW without modifying the defect landscape near the interface. Therefore the system can be tuned in a reversible manner.

In summary, we have studied the electron trapping phenomenon in LAO/STO heterostructures under back-gate voltages. By combing magnetotransport measurements and self-consistent Schrödinger-Poisson calculations, we have identified a relation between the amount of trapped electrons and the gate voltage as well as the spatial distribution of the trapped electrons. We have proposed a new trapping mechanism which involves the electromigration and clustering of oxygen vacancies in STO, since our analysis shows that the thermal escape mechanism is not valid. Our work improves the understanding of back-gating experiments in LAO/STO heterostructures. It is also valuable for theoretical works [33, 47, 48], where the assumption was that all the gate-induced electrons land in the QW. This assumption clearly needs to be reconsidered. Equally importantly, our work indicates that electron trapping is a universal phenomenon in SrTiO₃-based two-dimensional electron systems, which is instructive to future applications of complex oxide electronic devices.

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Supplemental Material

HALL BAR DEVICE FABRICATION

Before the Hall bar device fabrication, the SrTiO₃ (001) substrate ($5 \times 5 \times 0.5$ mm³) (CrysTec GmbH) was etched by buffered hydrofluoric acid and annealed at 980 °C in an oxygen flow of 150 sccm for 1 h in order to form a TiO₂-terminated surface [49]. The device was fabricated by photolithography. First, a resist mask was patterned (Fig. 6(a)-(c)). The photoresist was OiR 907-12 (Fujifilm) and the exposure time was 6 s. The developer was OPD 4262 (Fujifilm) and the development time was 1 min. Next, a 15 nm AlO_x layer was sputtered as a hard mask (Fig. 6(d)). The resist mask was then lifted by acetone (Fig. 6(e)). Finally, a 15 unit cells LaAlO₃ film was deposited by 90° off-axis sputtering (Fig. 6(f)). The LAO film was grown at 800 °C in an Ar pressure of 0.04 mbar, followed by an *in situ* oxygen annealing treatment at 600 °C in 1 mbar of oxygen for 1 h [23]. Only the interface between crystalline LAO and STO was conducting. The width of the Hall bar was 150 μm and the length was 1.0 mm. AFM images of the Hall bar channel before and after LAO film deposition are shown in Fig. 7. Atomic steps with an average terrace width of 100 nm can be clearly observed before and after deposition.

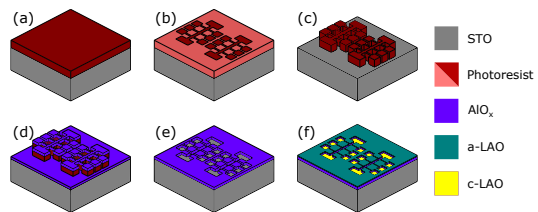


FIG. 6. Schematic representation of the Hall bar device fabrication process. (a) Spin coating. (b) Exposure. (c) Development. (d) AlO_x hard mask deposition. (e) Lift-off. (f) LaAlO₃ film deposition. a-LaAlO₃ and c-LaAlO₃ stand for amorphous LaAlO₃ and crystalline LaAlO₃, respectively. Only the interface between c-LAO and STO is conducting.

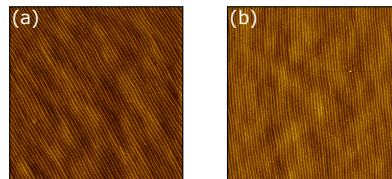


FIG. 7. AFM images (5×5 μm²) of the Hall bar channel taken before (a) and after (b) LaAlO₃ film deposition.

GATE VOLTAGE SWEEPS ON A FILM SAMPLE MEASURED IN THE VAN DER PAUW GEOMETRY

We also measured an unpatterned film sample in the van der Pauw geometry at 4.2 K. V_G was swept between ± 150 V. As shown in Fig. 8, the metal-insulator transition (MIT) was not observed in this case. Similar $R_s - V_G$ dependence has been reported in Ref. [19]. The explanation might be that in the van der Pauw geometry the conduction paths are not strictly defined. It is possible to measure R_s even at the maximum negative V_G . While in the Hall bar device, it is easier to pinch off the narrow contacts than the wide channel, resulting in the observed MIT [28].

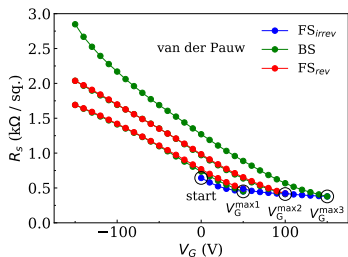


FIG. 8. V_G dependence of R_s measured on an unpatterned film sample in the van der Pauw geometry.

CARRIER DENSITY AND MOBILITY FITTING

The carrier density and mobility of the d_{xy} and $d_{xz,yz}$ bands were extracted by fitting the magnetotransport data with a two-band model [26]:

$$R_{xy} = \frac{B}{e} \frac{\frac{n_1 \mu_1^2}{1 + \mu_1^2 B^2} + \frac{n_2 \mu_2^2}{1 + \mu_2^2 B^2}}{\left(\frac{n_1 \mu_1}{1 + \mu_1^2 B^2} + \frac{n_2 \mu_2}{1 + \mu_2^2 B^2}\right)^2 + \left(\frac{n_1 \mu_1^2 B}{1 + \mu_1^2 B^2} + \frac{n_2 \mu_2^2 B}{1 + \mu_2^2 B^2}\right)^2}, \quad (5)$$

with the constraint $1/R_s = en_1\mu_1 + en_2\mu_2$, where n_1 and n_2 are the carrier densities of the d_{xy} and $d_{xz,yz}$ bands, and μ_1 and μ_2 are the corresponding mobilities. The fitting of the irreversible forward sweep (FS_{irrev}) and backward sweep (BS) regimes is shown in Fig. 9. The fitting of the reversible forward sweep (FS_{rev}) regimes is similar to that of BS, which is therefore omitted.

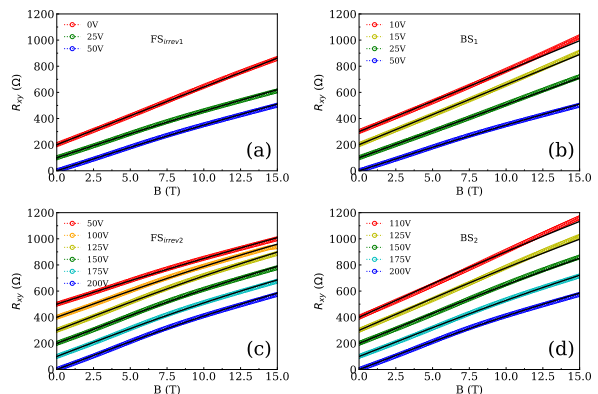


FIG. 9. Two-band model fitting of the transverse resistance versus magnetic field at different gate voltages in regime of (a) First FS_{irrev}, (b) First BS, (c) Second FS_{irrev}, and (d) Second BS. The black lines are the fitting curves. The curves are separated by an offset for clarity.

GATE VOLTAGE SWEEPS ON REFERENCE DEVICES

Two reference devices were fabricated under the same conditions as described above and the same V_G sweeps were performed. As shown in Fig. 10, the two samples behave slightly differently, which indicates that the amount of defects and their distribution at the interface are different from sample to sample.

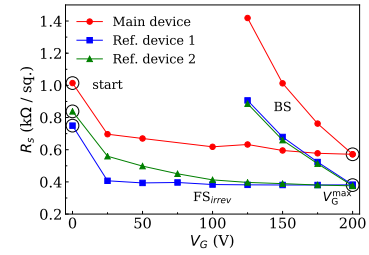


FIG. 10. R_s versus V_G of two reference devices at 4.2 K.

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